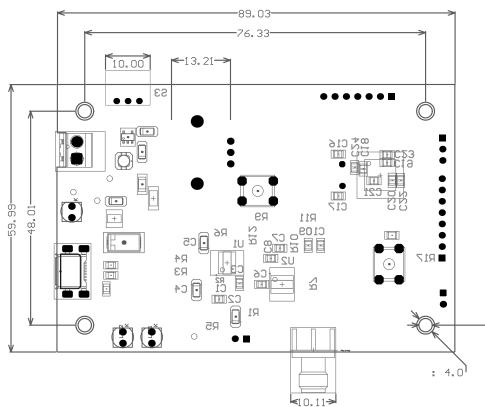


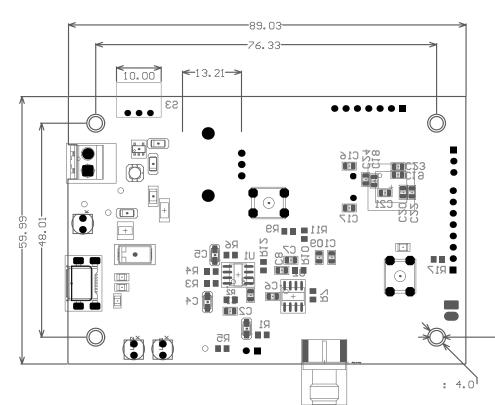
Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	Top Overlay				
2	Top Solder	Solder Resist	O. 010mm	3.5	
3	Component Side	Copper	0.036mm		
4	Dielectric 1	FR-4	0.320mm	4.8	
5	Signal Layer 1	Copper	0.036mm		
6	Dielectric 3		O.127mm	4.2	
7	Power Plane	Copper	0.036mm		
8	Dielectric 4		0.254mm	4.2	
9	Solder Side	Copper	0.036mm		
10	Bottom Solder	Solder Resist	O. 010mm	3.5	
11	Bottom Overlay		·		

2.99



Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	Top Overlay				
2	Top Solder	Solder Resist	O. 010mm	3.5	
3	Component Side	Copper	0.036mm		
4	Dielectric 1	FR-4	0.320mm	4.8	
5	Signal Layer 1	Copper	0.036mm		
6	Dielectric 3		O.127mm	4.2	
7	Power Plane	Copper	0.036mm		
8	Dielectric 4		0.254mm	4.2	
9	Solder Side	Copper	0.036mm		
10	Bottom Solder	Solder Resist	O. 010mm	3.5	
11	Bottom Overlay				

2.99



**≥**10.11>

Layer	Name	Material	Thickness	Constant	Board Layer Stack
1	Top Overlay				
2	Top Solder	Solder Resist	O. 010mm	3.5	
3	Component Side	Copper	0.036mm		
4	Dielectric 1	FR-4	0.320mm	4.8	
5	Signal Layer 1	Copper	0.036mm		
6	Dielectric 3		O.127mm	4.2	
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9	Solder Side	Copper	0.036mm		
10	Bottom Solder	Solder Resist	O. 010mm	3.5	
11	Bottom Overlay		·		

2.99